

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
HAYLEY ANN REECE	01/23/2020
JOSEPH EDWARD GORDON BENSON	01/23/2020
SARAH COLLINS	01/23/2020
RECEIVING PARTY DATA	
Name:	SOLID FORM SOLUTIONS, LTD.
Street Address:	1 THE FLEMING BUILDING
City:	EDINBURGH TECHNOPOLE, SCOTLAND
State/Country:	UNITED KINGDOM
Postal Code:	EH26 0BE
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	16775142
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SIGNATURE:	/Shae Jackson/
DATE SIGNED:	09/20/2021
Total Attachments: 2	
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ASSIGNMENT

WHEREAS, WE, **Hayley Ann Reece**, having a mailing address of 5A Miners Walk, Dalkeith, UK, EH22 2AL, Great Britain, residing at Dalkeith, Great Britain, **Joseph Edward Gordon Benson**, having a mailing address of 132 (2F4) Comiston Road, Edinburgh, UK, EH10 5QN, Great Britain, residing at Edinburgh, Great Britain, and **Sarah Collins**, having a mailing address of Flat 2, 4 Appin Place, Edinburgh, UK, EH14 1PW, Great Britain, residing at Edinburgh, Great Britain, ASSIGNORS, are co-inventors of the invention in **SULCARDINE SALTS** for which a provisional application for a Patent of the United States has been filed

- ☒ which is identified by Jones Day docket no. 13414-036-888 (CAM 247404-888036); Huya Ref. 3000.SALTS.US.PR.V2
☒ which was filed on January 10, 2020, Application No. 62/959,687

and WHEREAS, **Solid Form Solutions, Ltd.**, having an office for the transaction of business at 1 The Fleming Building, Edinburgh Technopole, Scotland, UK, EH26 0BE, ASSIGNEE, is desirous of obtaining our entire right, title and interest in, to and under the said invention and the said application:

NOW, THEREFORE, for good and valuable consideration, the receipt of which is hereby acknowledged, we, the said ASSIGNORS, have sold, assigned, transferred and set over, and by these presents do hereby sell, assign, transfer and set over, unto the said ASSIGNEE, its successors, legal representatives and assigns, our entire right, title and interest in, to and under the said invention, and the said United States provisional application and all applications claiming priority thereto under 35 U.S.C. § 119(e) and all divisions, renewals and continuations thereof, and all Patents of the United States which may be granted thereon and all reissues and extensions thereof; and all applications for industrial property protection, including, without limitation, all applications for patents, utility models, and designs which may be filed for said invention in any country or countries foreign to the United States, together with the right to file such applications and the right to claim for the same the priority rights derived from said United States application under the Patent Laws of the United States, the International Convention for the Protection of Industrial Property, or any other international agreement or the domestic laws of the country in which any such application is filed, as may be applicable; and all forms of industrial property protection, including, without limitation, patents, utility models, inventors' certificates and designs which may be granted for said invention in any country or countries foreign to the United States and all extensions, renewals and reissues thereof; and all right to sue for infringement including past infringement.

AND WE HEREBY authorize and request the Commissioner for Patents and any Official of any country or countries foreign to the United States, whose duty it is to issue patents or other evidence or forms of industrial property protection on applications as aforesaid, to issue the same to the said ASSIGNEE, its successors, legal representatives and assigns, in accordance with the terms of this instrument.

AND WE HEREBY covenant and agree that we have full right to convey the entire interest herein assigned, and that we have not executed, and will not execute, any agreement in conflict herewith.

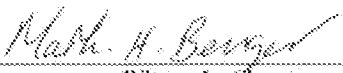
AND WE HEREBY further covenant and agree that we will communicate to the said ASSIGNEE, its successors, legal representatives and assigns, any facts known to us respecting said invention, and testify in any legal proceeding, sign all lawful papers, execute all divisional, continuing, reissue and foreign applications, make all rightful oaths, and generally do everything possible to aid the said ASSIGNEE, its successors, legal representatives and assigns, to obtain and enforce proper protection for said invention in all countries.

IN TESTIMONY WHEREOF, We hereunto set our hands and seals the day and year set opposite our respective signatures.

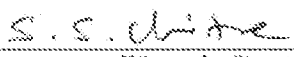
Date 23 Jan 2020


 Hayley Ann Reece L.S.

Date 23 Jan 2020


 Witness 1 - Signature
 MARK H. BERGER
 Witness 1 - Printed Name

Date 23 JAN 2020


 Witness 2 - Signature
 SAURABH CHITRE
 Witness 2 - Printed Name

Date 23 Jan 2020

Joseph Edward Gordon Benson

U.S.

Date 23 Jan 2020

Mark H. Bengel
Witness 1 - Signature

MARK BENGER

Witness 1 - Printed Name

Date 23 Jan 2020

S.S. Chitre
Witness 2 - Signature

SAURABH CHITRE

Witness 2 - Printed Name

Date 23 Jan 2020

Sarah Collins

U.S.

Date 23 Jan 2020

Mark H. Bengel
Witness 1 - Signature

MARK BENGER

Witness 1 - Printed Name

Date 23 Jan 2020

S.S. Chitre
Witness 2 - Signature

SAURABH CHITRE

Witness 2 - Printed Name

ACCEPTED AND AGREED TO BY ASSIGNEE, Solid Form Solutions, Ltd.:

Signature: Mark H. Bengel

Date: 23 Jan 2020

Printed Name: MARK BENGER

Title: Sr Director